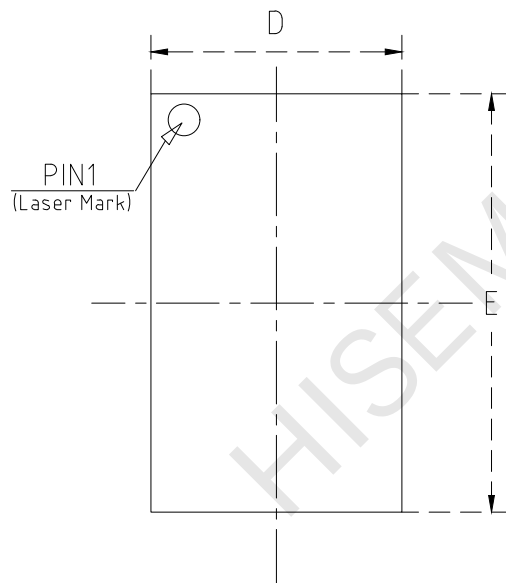


ROHS

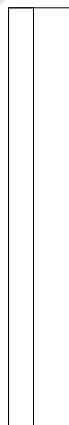
TOP VIEW

正视图



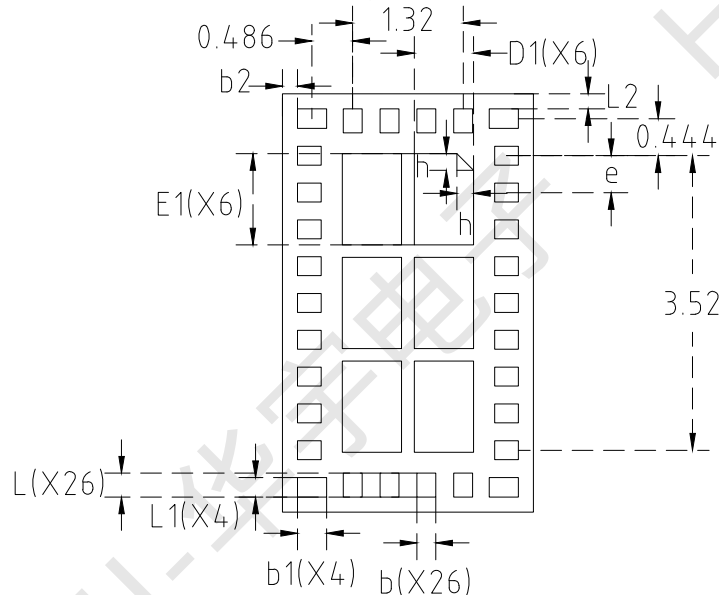
SIDE VIEW

侧视图



BOTTOM VIEW

背视图

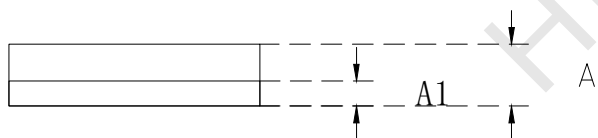


机械尺寸/mm

字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	0.690	0.740	0.790
A1	0.270	0.300	0.330
b	0.175	0.225	0.275
b1	0.298	0.348	0.398
D	2.950	3.000	3.050
D1	0.660	0.710	0.760
e	0.440 BSC		
L2	0.180 REF		
b2	0.180 REF		
h	0.200 REF		
E	4.950	5.000	5.050
E1	1.04	1.090	1.14
L	0.235	0.285	0.335
L1	0.183	0.233	0.283

SIDE VIEW

侧视图



 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD				制图: Draw	NINGLIN 2025. 2. 17
HY-POD-LGA0051				制图核查: Drawing review	
PACKAGE OUTLINE DIMENSIONS LGA36L (3X5X0.74-P0.44)				审核: Checker	
页数 page	单位 unit	比例 scale	视图 view	核准:	
1	mm	1:1		Approved	